

#### 2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP



**ATTENTION OBSERVE PRECAUTIONS** FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE DEVICES

Part Number: KA-2810AZGS

Green

#### **Features**

- 2.8mmX0.8mm right angle SMT LED, 1.2mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- · RoHS compliant.

#### **Description**

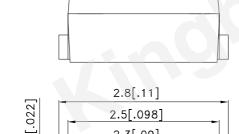
The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

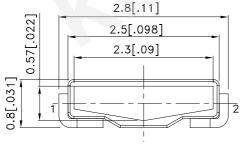
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

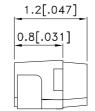
All devices, equipment and machinery must be electrically grounded.

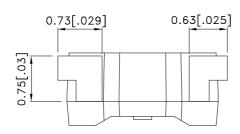
### **Package Dimensions**

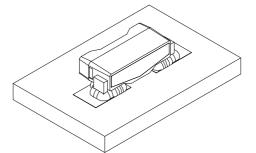












- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.0039") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

  4. The device has a single mounting surface. The device must be mounted according to the specifications.

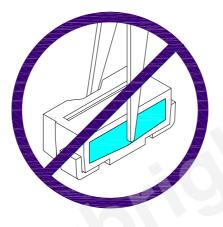
SPEC NO: DSAK2455 **REV NO: V.5B DATE: FEB/23/2013** PAGE: 1 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1201005916

#### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



2. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Detailed application notes are listed on our website. <a href="http://www.kingbright.com/application\_notes">http://www.kingbright.com/application\_notes</a>

SPEC NO: DSAK2455 REV NO: V.5B DATE: FEB/23/2013 PAGE: 2 OF 6

APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1201005916

#### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		-	Min.	Тур.	201/2
KA-2810AZGS	Green (InGaN)	Water Clear	400	700	110°

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.
- 3.Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
lR	Reverse Current	Green		50	uA	V <sub>R</sub> =5V

#### Notes:

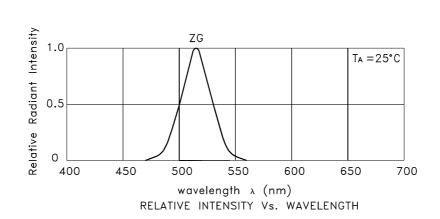
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

### Absolute Maximum Ratings at TA=25°C

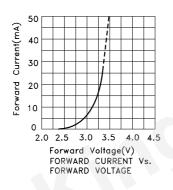
Parameter	Green		
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

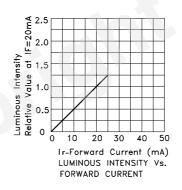
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

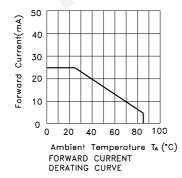
SPEC NO: DSAK2455 **REV NO: V.5B DATE: FEB/23/2013** PAGE: 3 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1201005916

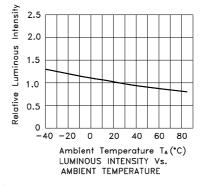


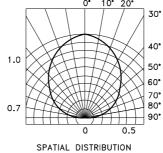
Green KA-2810AZGS









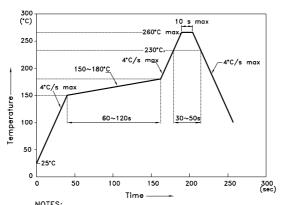


SPEC NO: DSAK2455 REV NO: V.5B DATE: FEB/23/2013 PAGE: 4 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1201005916

#### **KA-2810AZGS**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



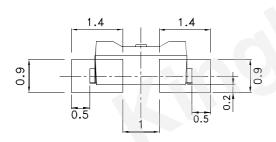
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

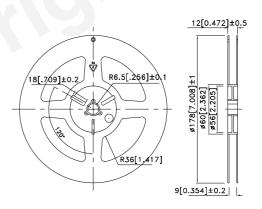
  3.Number of reflow process shall be 2 times or less.

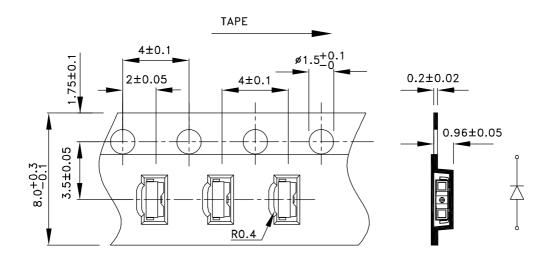
### Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### Tape Dimensions (Units: mm)

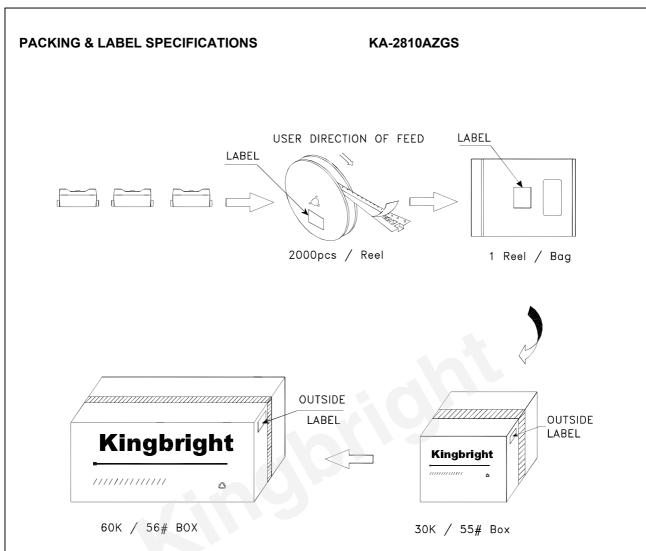
#### **Reel Dimension**

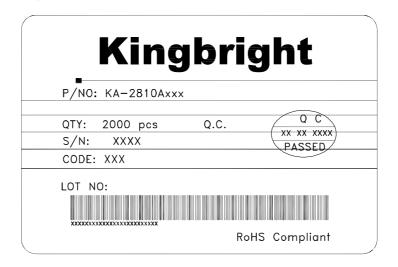




 SPEC NO: DSAK2455
 REV NO: V.5B
 DATE: FEB/23/2013
 PAGE: 5 OF 6

 APPROVED: WYNEC
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SPEC NO: DSAK2455 APPROVED: WYNEC REV NO: V.5B CHECKED: Allen Liu DATE: FEB/23/2013 DRAWN: Y.Liu PAGE: 6 OF 6 ERP: 1201005916